



# New RF Amplifiers based on GaN Semiconductors

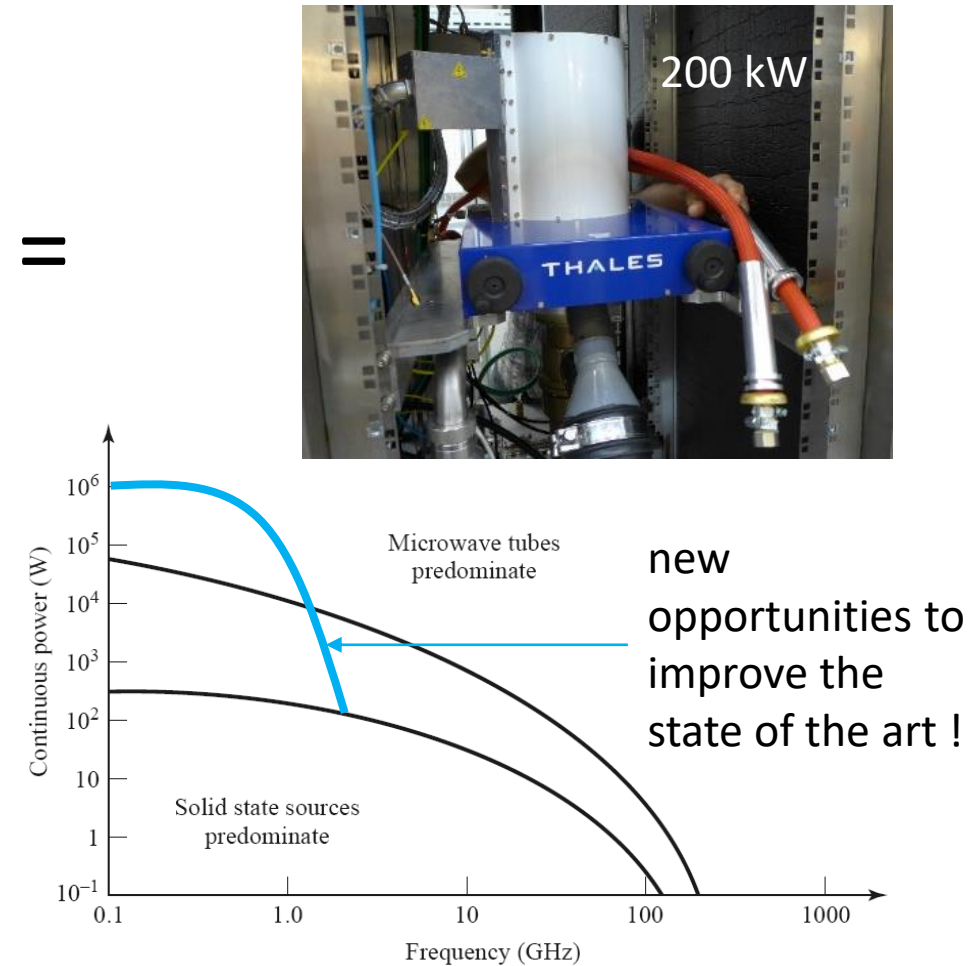
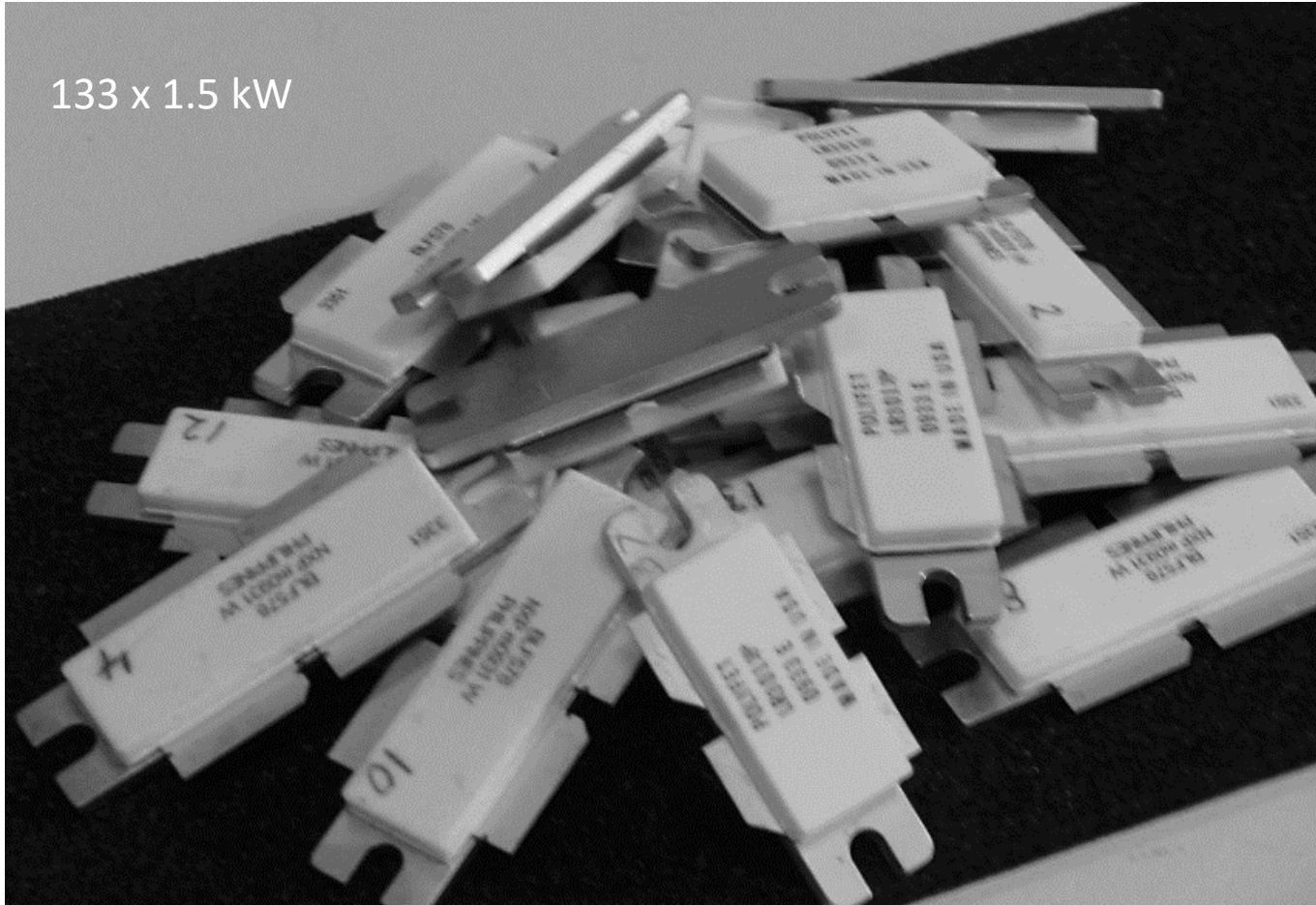
[dragos.dancila@angstrom.uu.se](mailto:dragos.dancila@angstrom.uu.se)

on behalf of the FREIA laboratory

Workshop on efficient RF sources

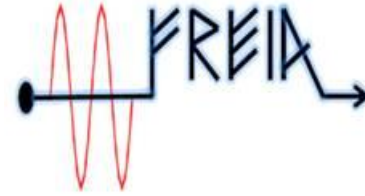
04-06 July 2022, CERN, Chateau de Bossey, Switzerland

# Research Programme @ FREIA on SSPAs improve SoA of transistor amplifiers for accelerators





# SSPA projects at FREIA\*



- 352 MHz – ESS

- 1.25 kW module – single ended architecture
- Gysel combiner 10 kW
- 10 kW 5% DC – prototype
- Gysel combiner 20 kW – air stripline technology
- 100 kW non-resonant circular power combiner



AMPLEON

- 27 MHz – 1 kW module GE Healthcare – EUROSTARS project



- 100 MHz – 10 kW amplifier GE Healthcare – EUROSTARS project

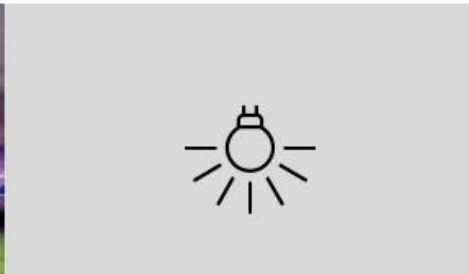
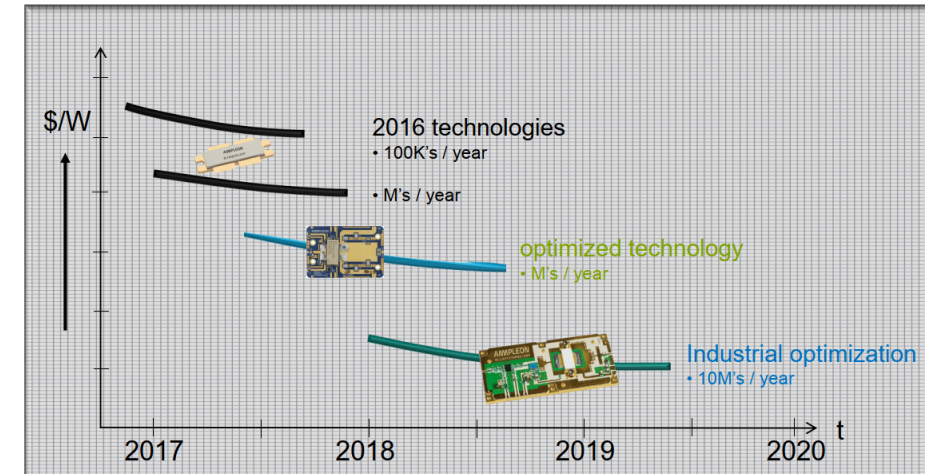
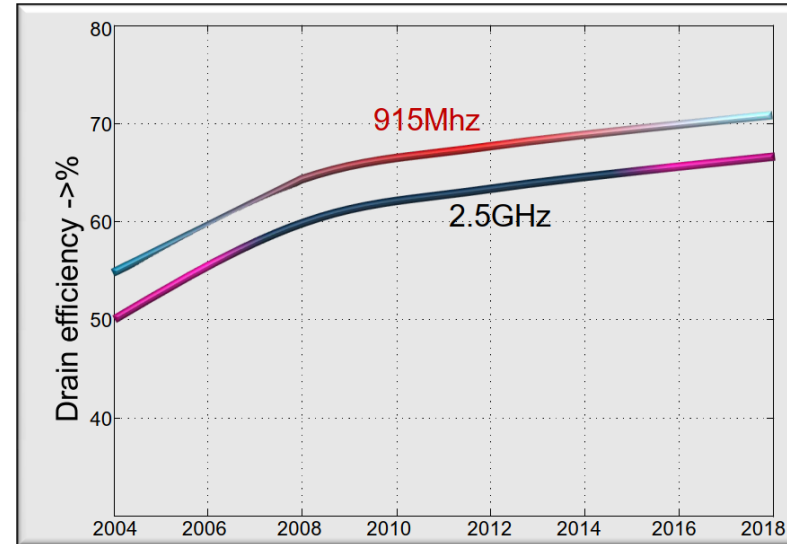
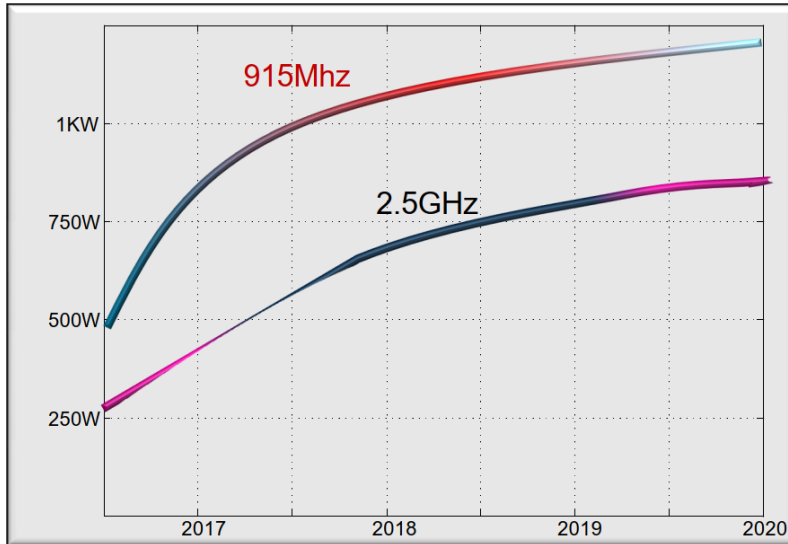
\* all are previous LDMOS developments



UPPSALA  
UNIVERSITET

# Power development LDMOS transistors

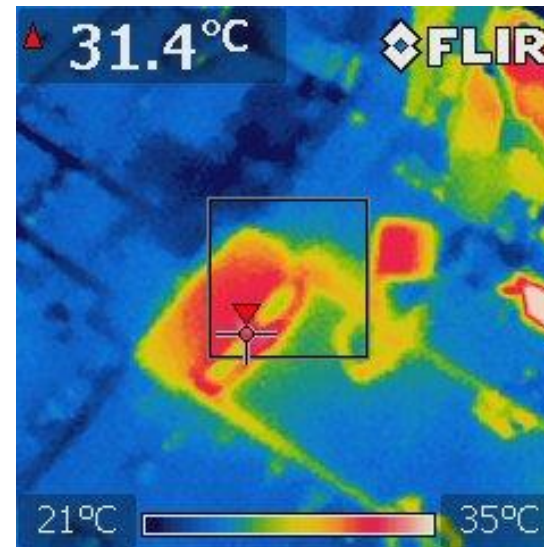
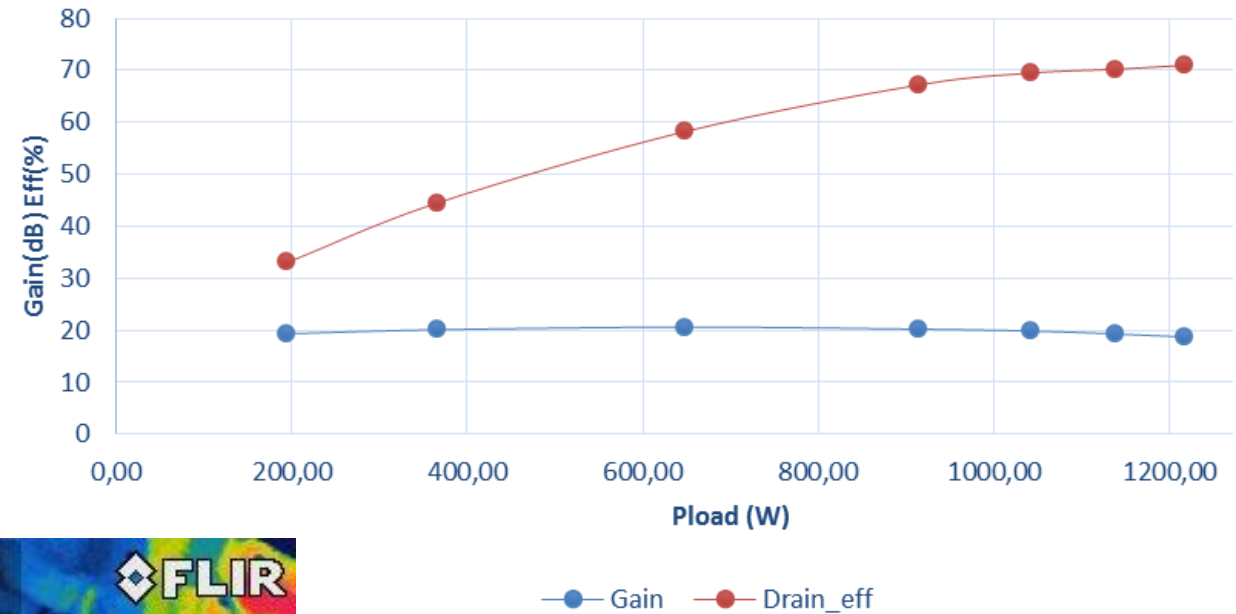
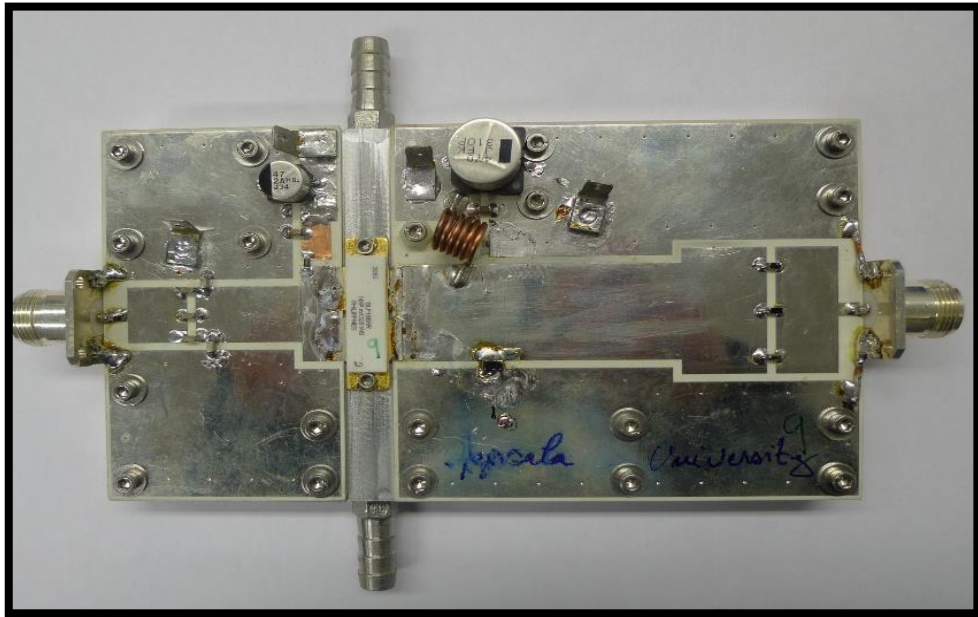
e.g. **AMPLEON**





UPPSALA  
UNIVERSITET

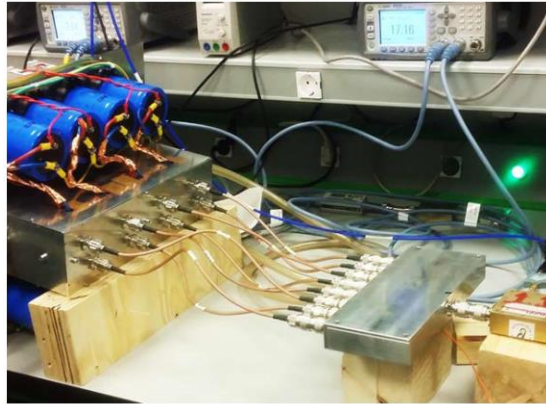
# Single ended RF power amplifier 352 MHz 1250 kW - 70% eff.



L. Haapala, A. Eriksson, L. D. Hoang and D. Dancila,  
"Kilowatt-level power amplifier in a single-ended  
architecture at 352 MHz," 2016, Electronics Letters,  
Vol. 52, no 18, p.1552-1553.

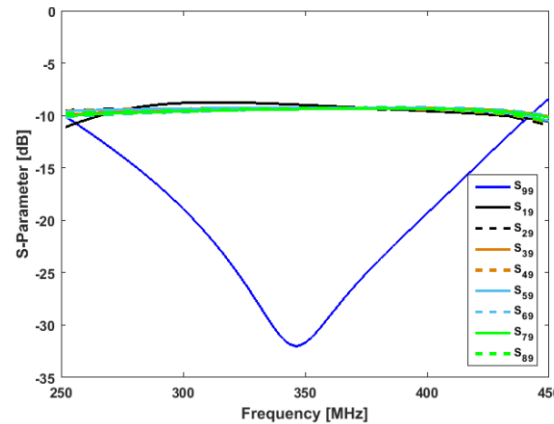
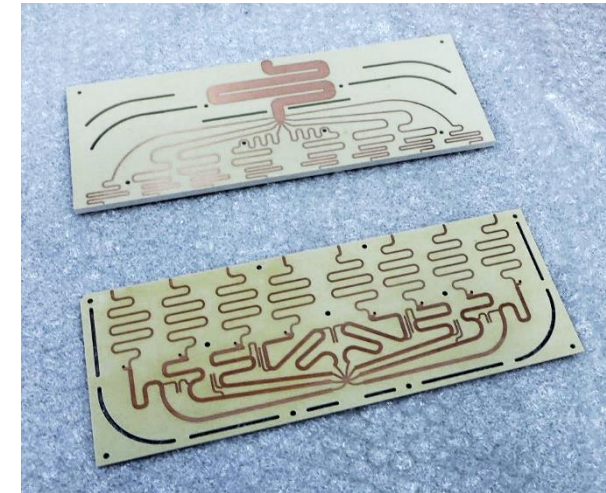
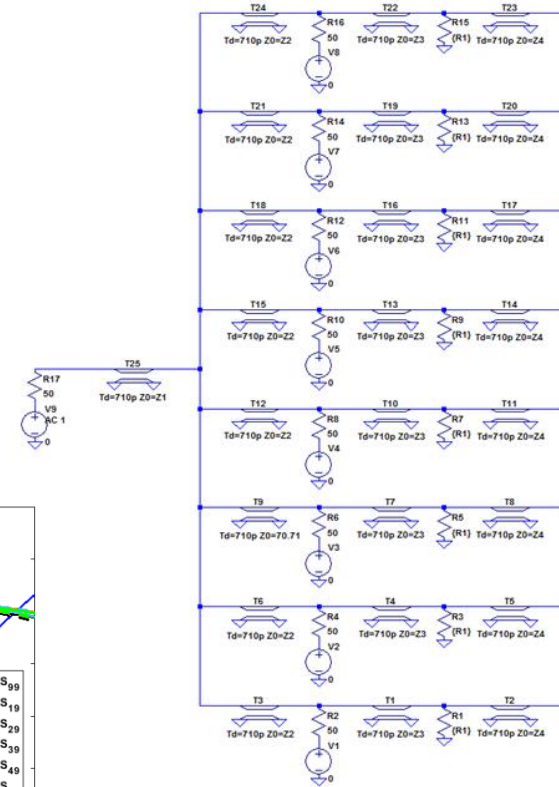
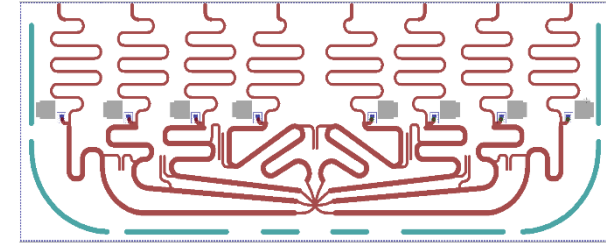
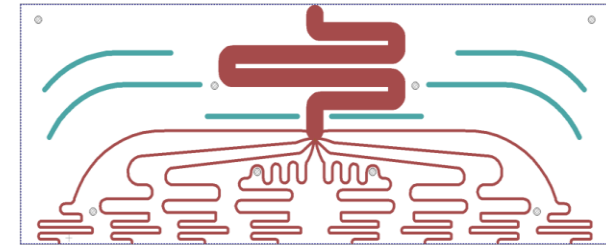


# Gysel Power Combiner 10 kW



## Key Parameters

- $S_{NN} < -20$  dB
- Losses  $< 0.1$  dB
- High Power Handling
- 240 x 100 x 30 mm

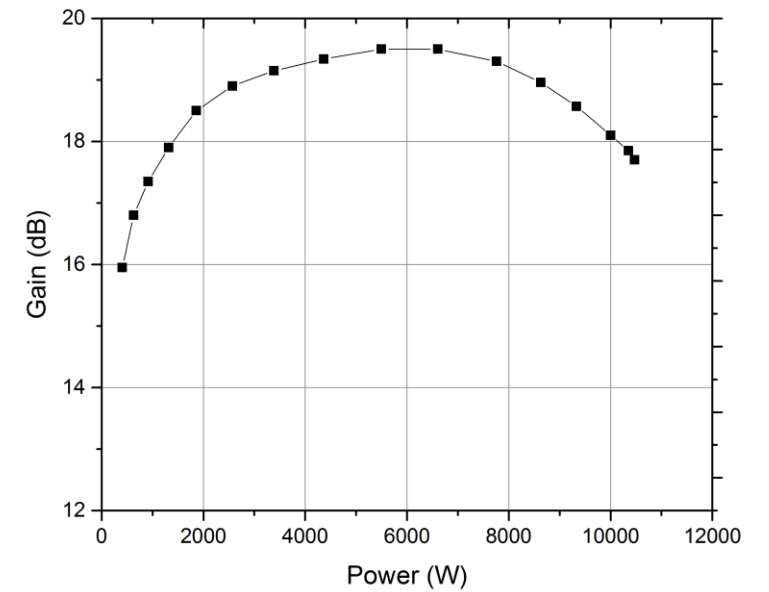
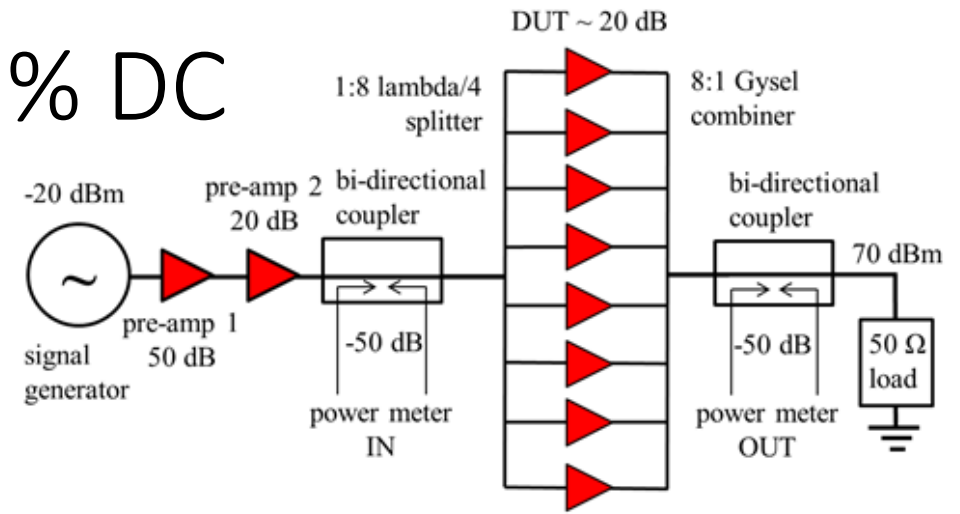


M. Jobs, D. Dancila, J. Eriksson and R. Ruber, "An 8-1 Single-Stage 10-kW Planar Gysel Power Combiner at 352 MHz," in *IEEE Transactions on Components, Packaging and Manufacturing Technology*, vol. 8, no. 5, pp. 851-857, May 2018.

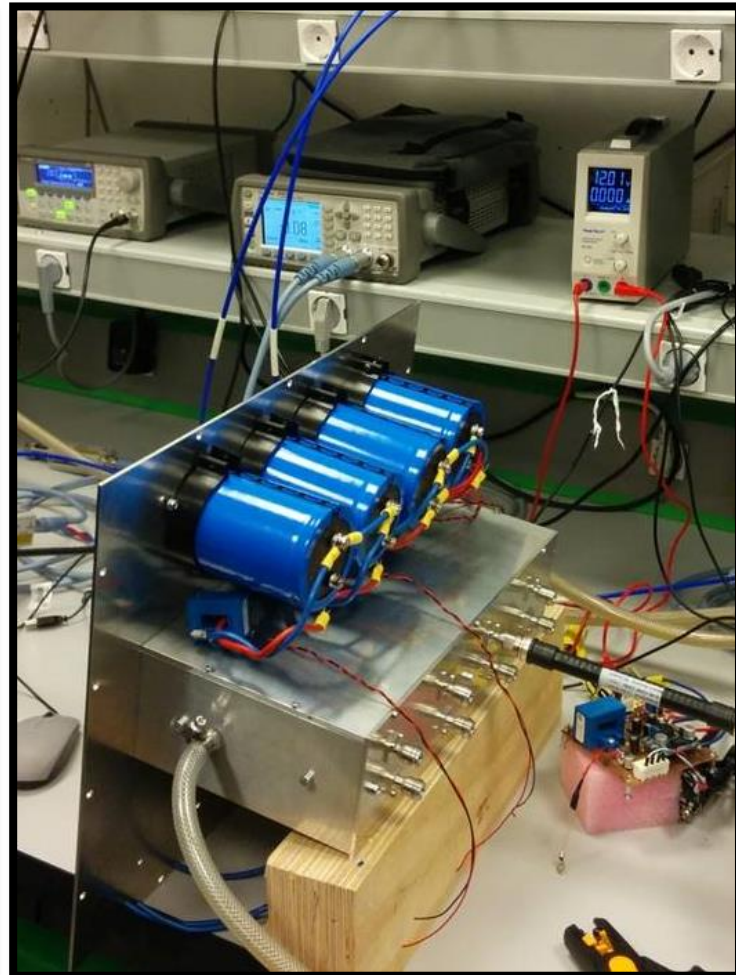


UPPSALA  
UNIVERSITET

# 10 kW HPA 352 MHz pulsed 5% DC



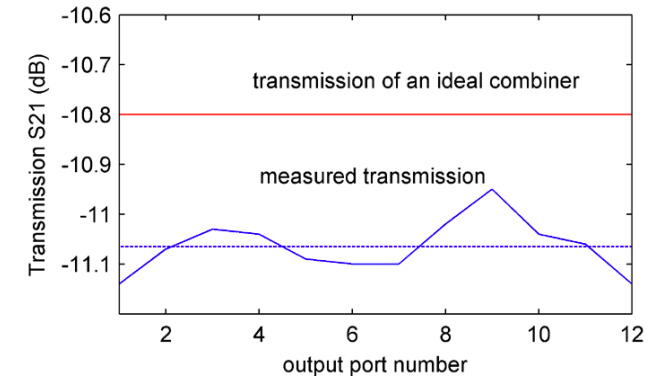
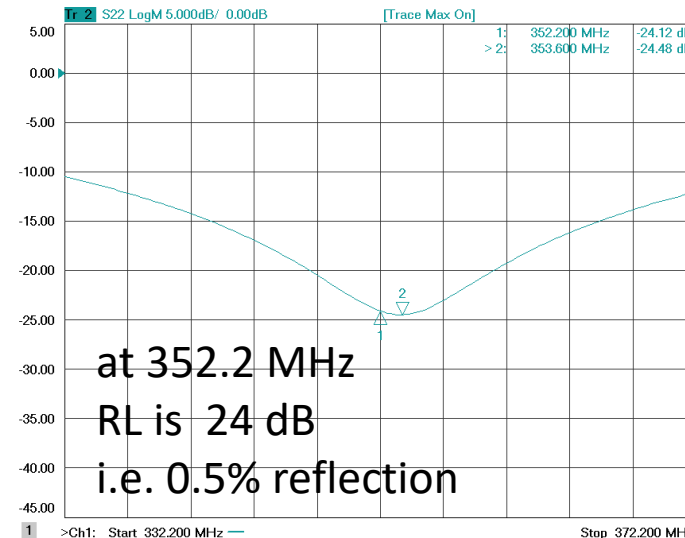
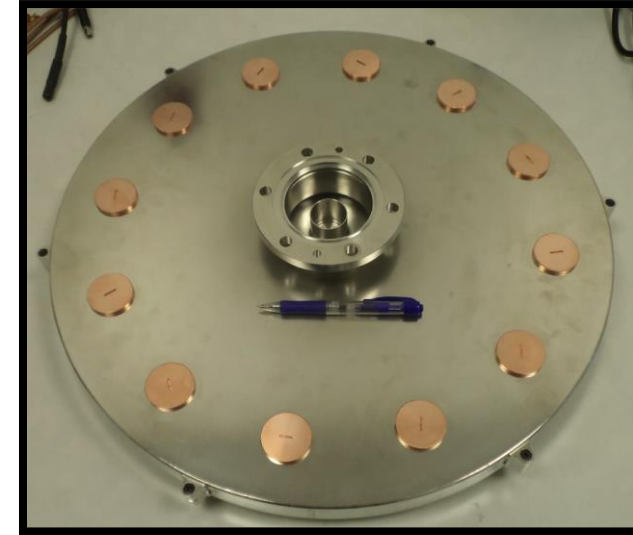
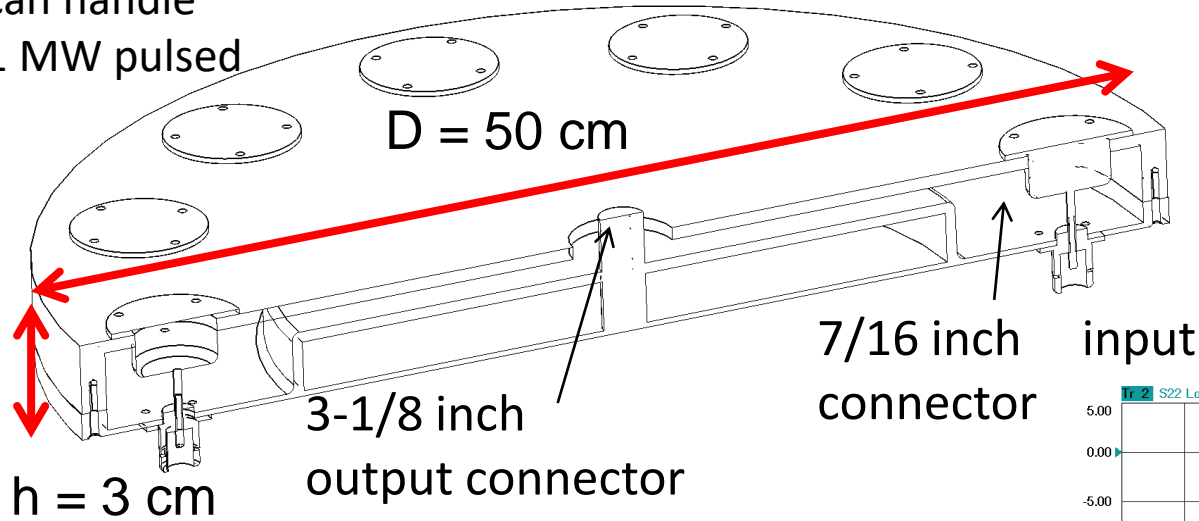
D. Dancila et al, "A compact 10 kW solid-state RF power amplifier at 352 MHz," 2017 IOP Conf. Series: Journal of Physics: Conf. Series, vol. 874, 012093





# 100 kW non-resonant power combiner with door-knob couplers at 352 MHz

can handle  
1 MW pulsed



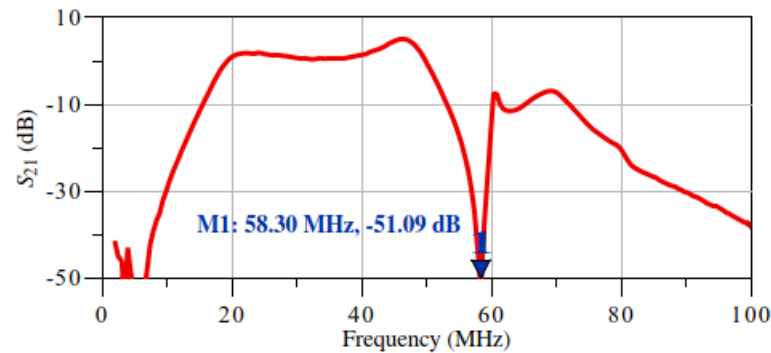
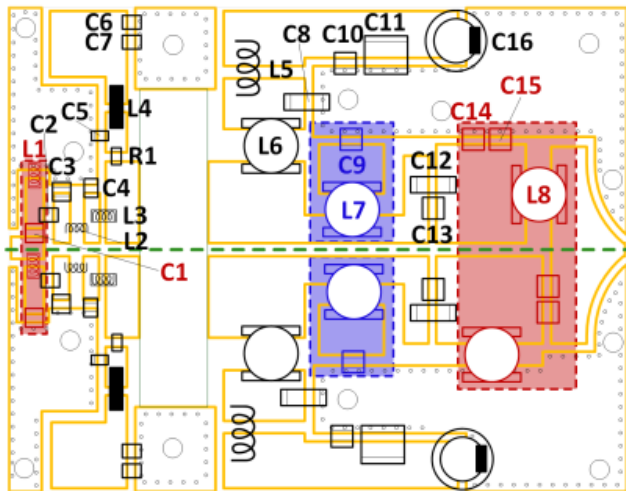
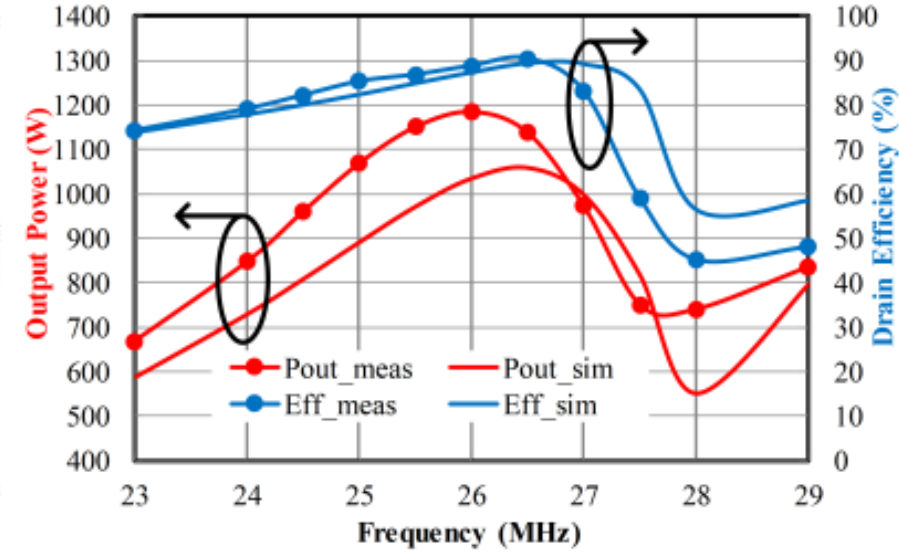
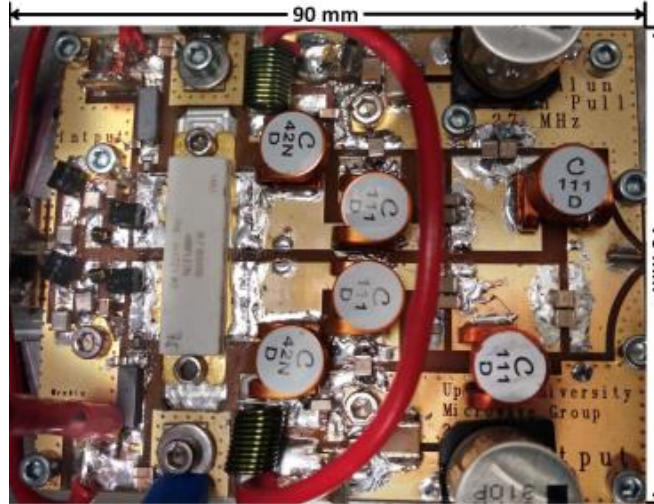
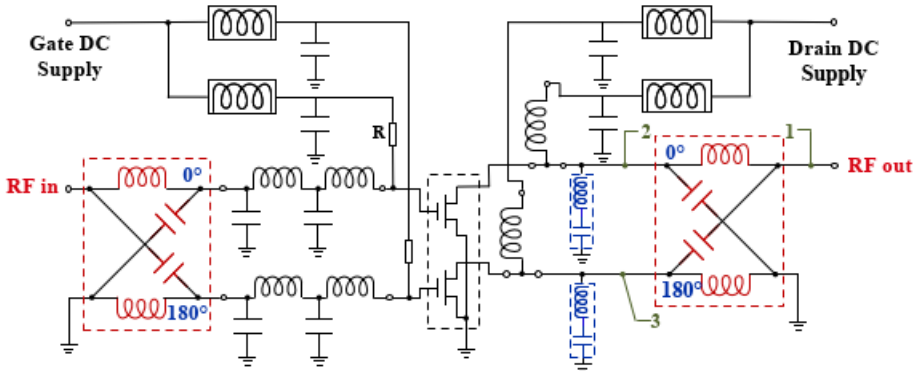
at 352.2 MHz  
IL is 0.3 dB i.e. 6% losses

V. A. Goryashko, D. Dancila, A. Rydberg, R. Yogi & R. Ruber (2014):  
A megawatt class compact power combiner for solid-state  
amplifiers, Journal of Electromagnetic Waves and Applications.





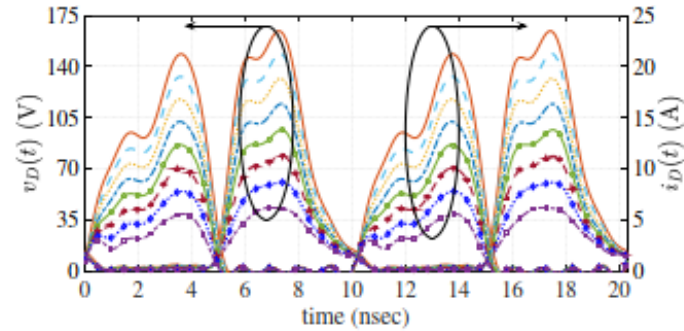
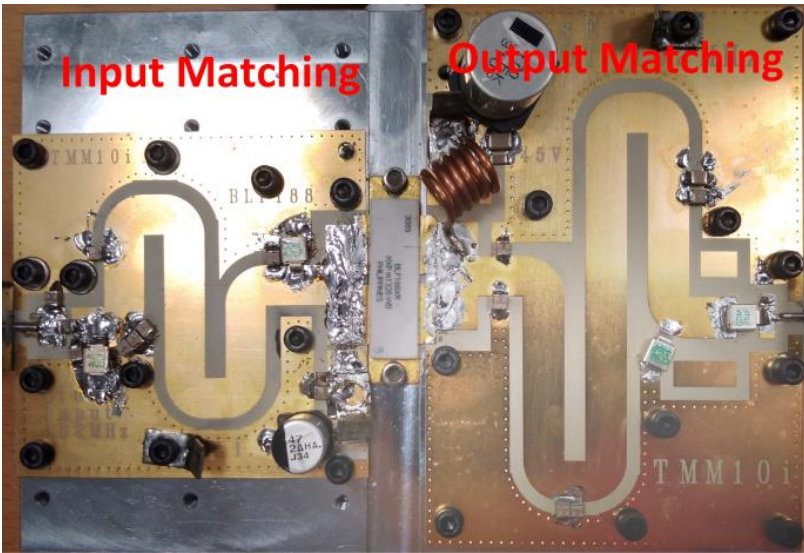
# SSPA at 27 MHz – 1kW – 90% eff.



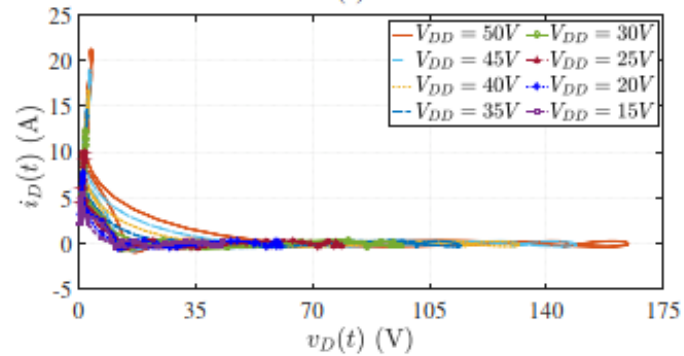
R. Tong and D. Dancila, "Compact and Highly Efficient Lumped Push-pull Power Amplifier at Kilowatt level with Quasi-static Drain Supply Modulation" in IEEE Transactions on Microwave Theory and Techniques, 2020.



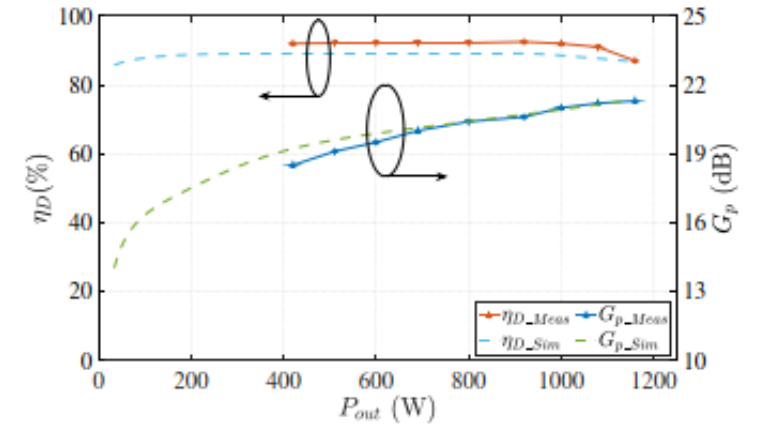
# SSPA design principles at 100 MHz – 1kW – 93% eff. waveform engineering



(a)



(b)



$$v_D(t) = V_{DD} \cdot [1 - \sqrt{2} \cos(\omega t) + 0.5 \cos(2\omega t)] \cdot [1 + \sin(\omega t)] \quad (1)$$

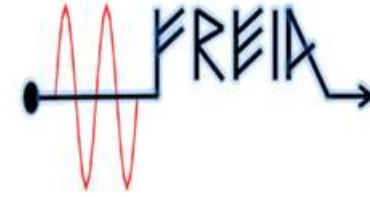
$$i_D(t) = I_{max} \cdot [0.274 + 0.406 \cos(\omega t) + 0.117 \cos(2\omega t) - 0.075 \cos(3\omega t) - 0.077 \cos(4\omega t) + 0.003 \cos(5\omega t) + \dots] \cdot [1 + 0.34 \sin(\omega t)] \quad (2)$$

$$Z_{nf_0} = -\frac{V_{d,n}}{I_{d,n}}$$

R. Tong, O. Bengtsson, A. Bäcklund and D. Dancila, "Highly Efficient Kilowatt Power Amplifier Module as RF Source for Radioisotope Production Cyclotron System", IEEE Transactions on Microwave Theory and Techniques, 2021.



# Ongoing SSPA projects at FREIA\*



- 352 MHz
  - 400 kW 10% DC – prototype fabrication – VR project
- 704 MHz
  - 1 kW CW – conceptual level - MYRRHA
- 750 MHz
  - 1 kW CW – 200 W module in GaN technology for EU I.FAST project
- 3 GHz
  - 400 W pulsed – AWAKE project (plasma wake field accelerator) – klystron driver
- 12 GHz
  - 1000 W pulsed – AWAKE project (plasma wake field accelerator) – klystron driver



EUROPEAN  
SPALLATION  
SOURCE



sck cen



\* in yellow, new GaN based developments



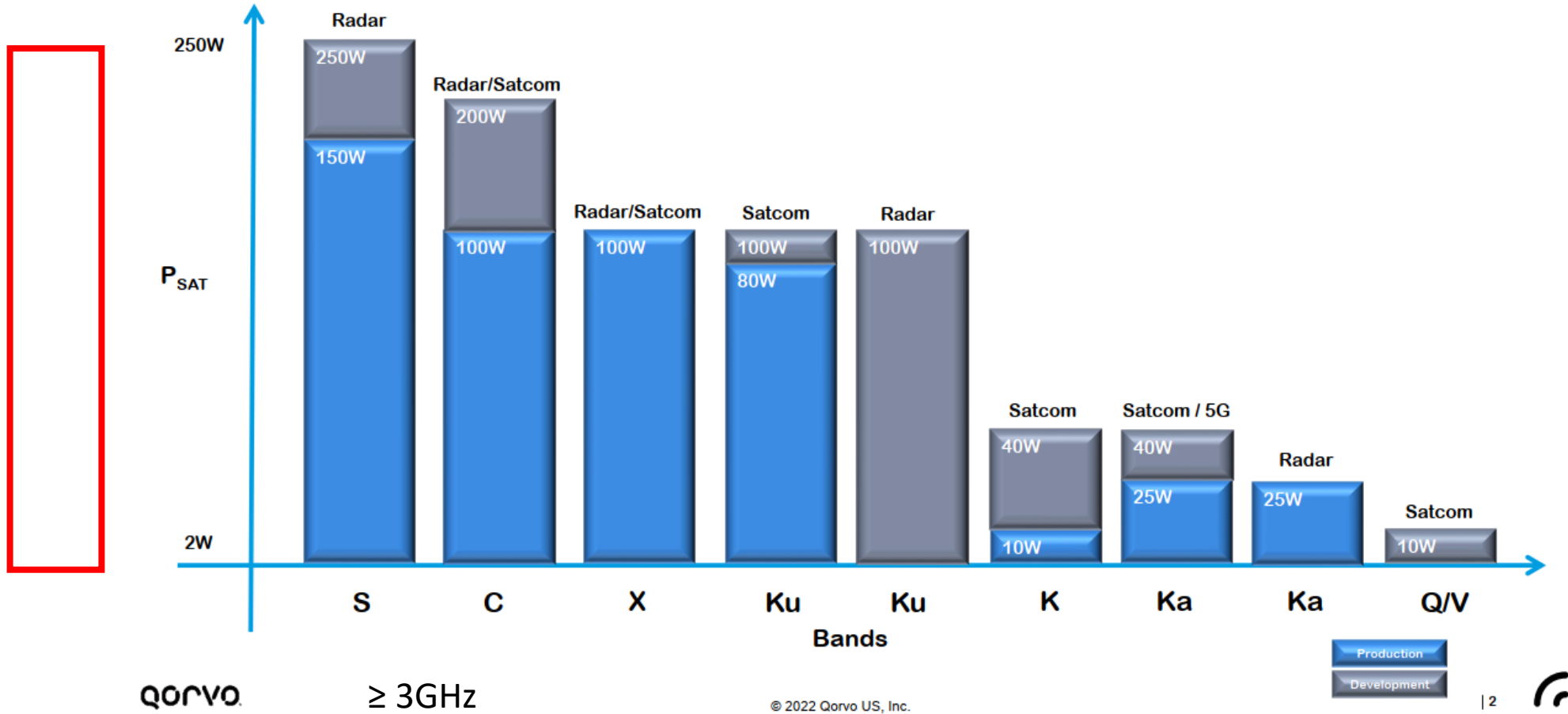
# State of the Art - GaN modules at 750 MHz

No.	Operating class	F <sub>min</sub> (MHz)	F <sub>max</sub> (MHz)	Operation Voltage (V)	P <sub>out</sub> (dBm)	Gain (dB)	PAE <sub>min</sub> (%)	Chip	F <sub>max</sub> of chip (MHz)	V <sub>DS</sub> max	Technology	Package	Institution
2020[8]	Class E	400	-	145	63.6	22	70	-	-	500	GaN	Die	Integra Tech. - CA
2018[9]	Class E	680	750	28	47	-	80	CGH35030F	3900	120	GaN	packaged	U. of Cantabria
2017[11]	Harmonic tuned	420	450	75	60	40 (two stages)	75	-	-	-	GaN	Packaged	Integra Tech. - CA
2017[12]	Class E	670	900	28	44.7	-	70	CGH35030F	3900	120	GaN	packaged	U. of Cantabria
2016[13]	Class F	704	-	-	58	-	79	-	-	-	GaN	packaged	Green Mountain Radio Research
2016[14]	Class F	550	950	28	40	15	75	CGH40010F	4000	120	GaN	packaged	U. of Calgary
2011[15]	Class F	550	1100	28	40	10	74	CGH40010F	4000	120	GaN	packaged	Cardiff U.

GaN transistors from e.g. Ampleon, Qorvo, Cree - Wolfspeed, NXP Semiconductors, Infineon, etc. are available at high power / high freq.

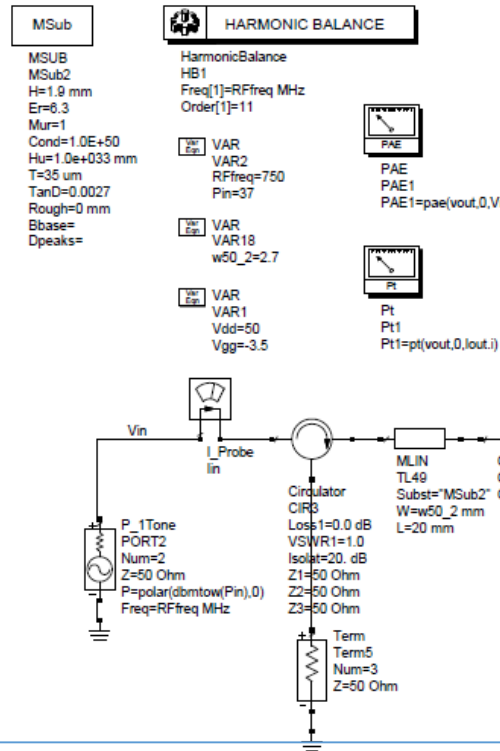
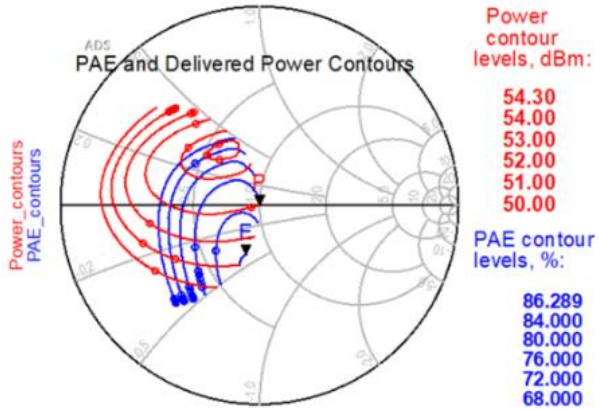
# GaN high power transistors – e.g. Qorvo

## Portfolio Summary – MMICs





# Load pull simulations and harmonics optimization



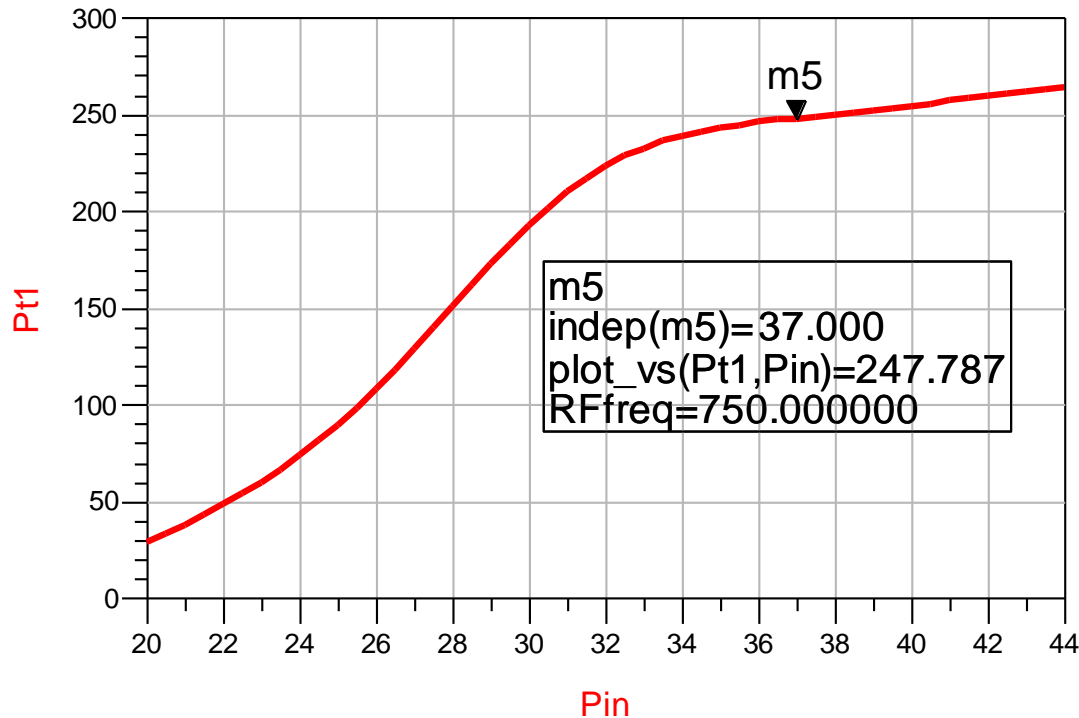
← Tuned 3rd harmonics

The maximum efficiency and output power are easily shifted by varying stub length, and so the practical implementation of the PA will meet the targeted specifications.



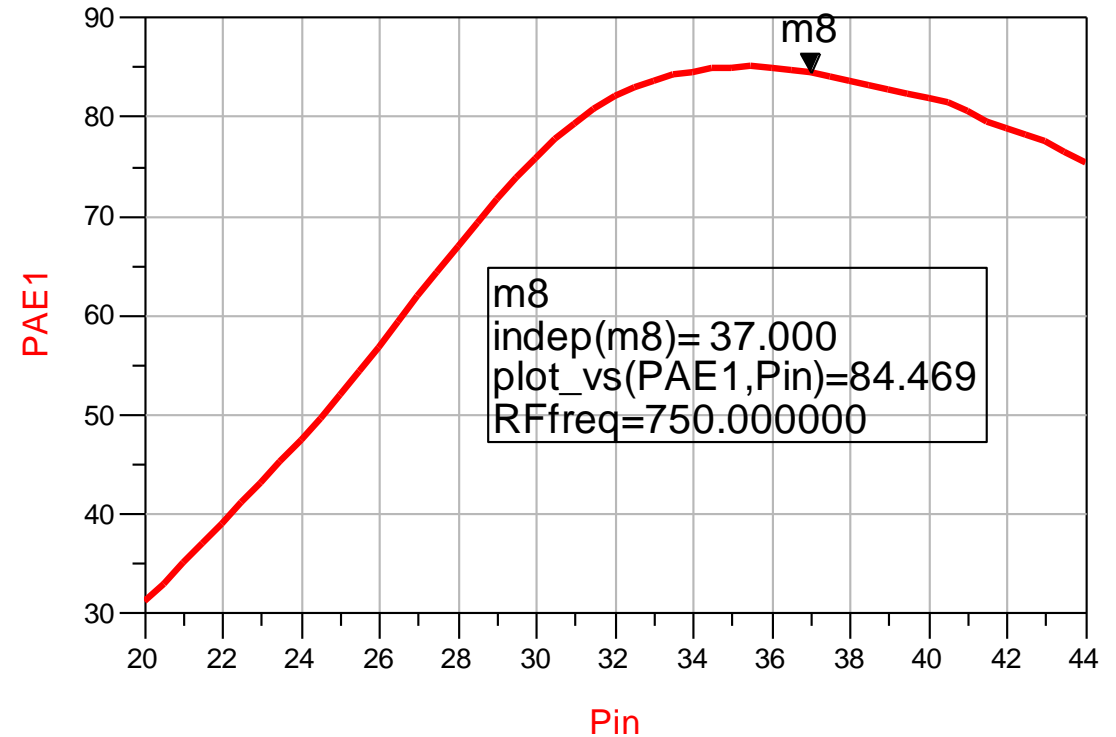
# Simulation results of the GaN SSPA at 750 MHz

Output power versus input power



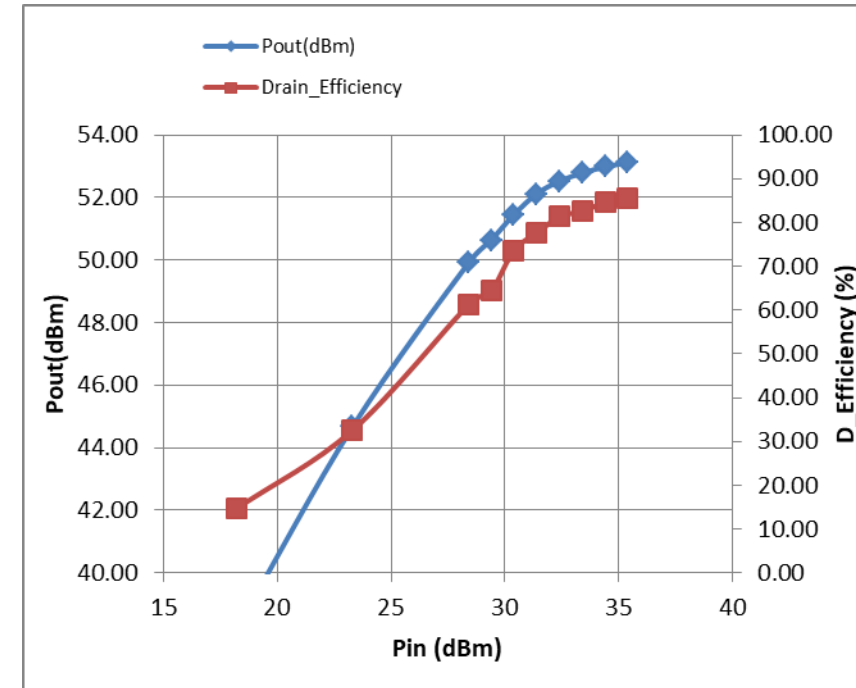
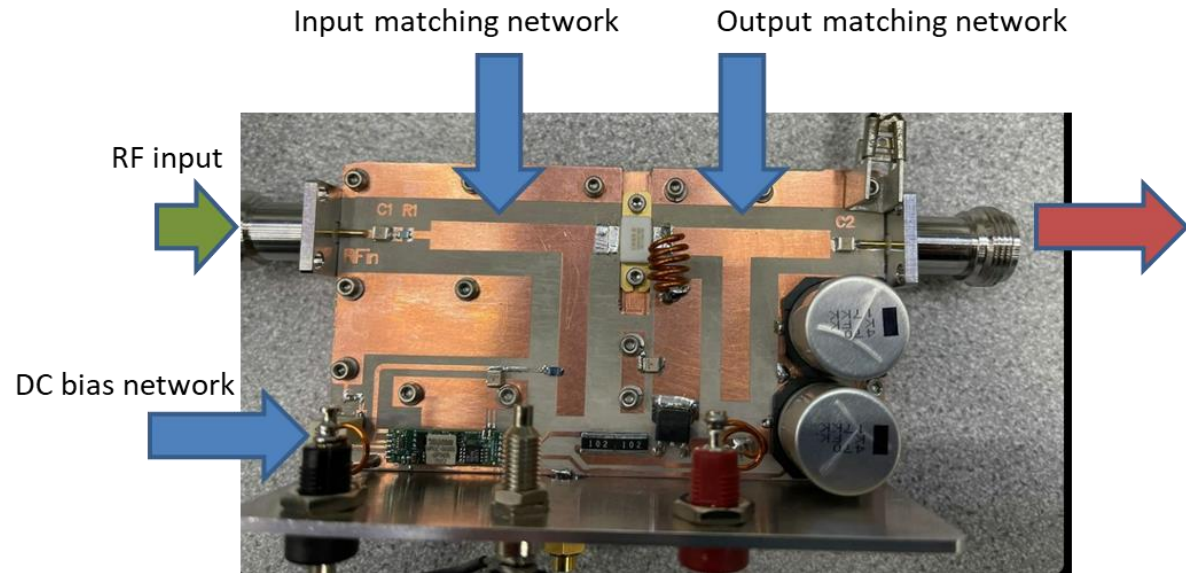
Pout=247 W (54 dBm) @ Pin=37 dBm  
Gain = 17 dB

Power added Efficiency (PAE) versus input power



PAE = 84.5 % @ Pin=37 dBm

# 750 MHz GaN amplifier in EU project I.FAST fabrication and first measurements



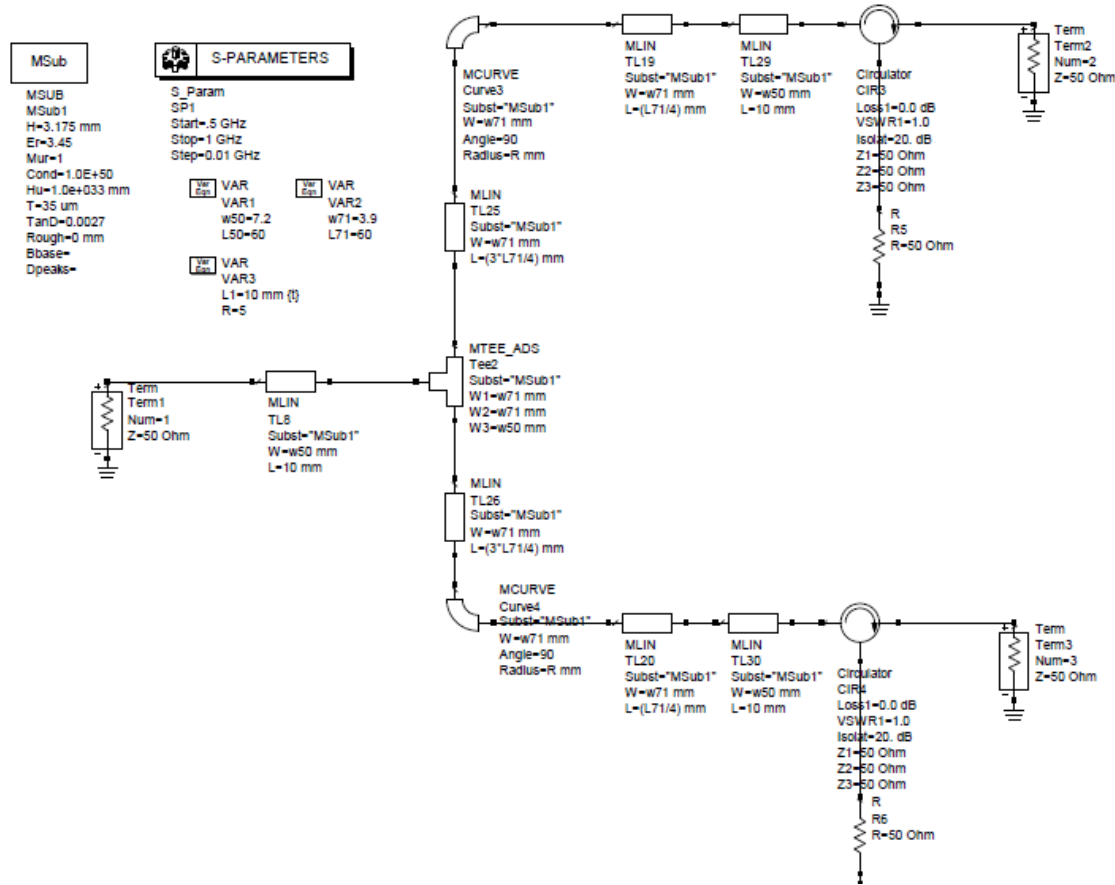
- A measured output power of 205 W was possible, with a signal gain of 17 dB and an efficiency of 84% in compression.
- This is improving the State of the Art.

$$P_{out} = 53 \text{ dBm (60 dBm with combiner)} / PAE = 84\% @ 750 \text{ MHz}$$

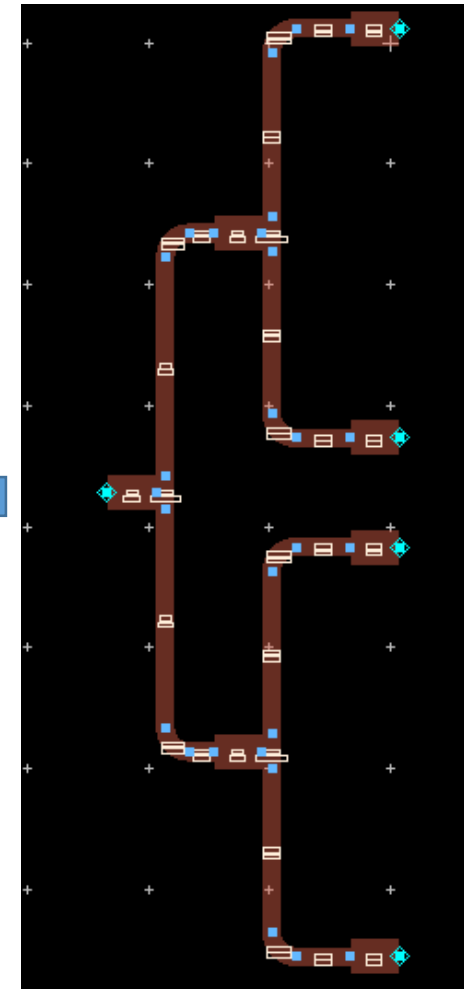




# Plannar Wilkinson power combiner 2:1, 4:1 and 6:1



output port



Port1

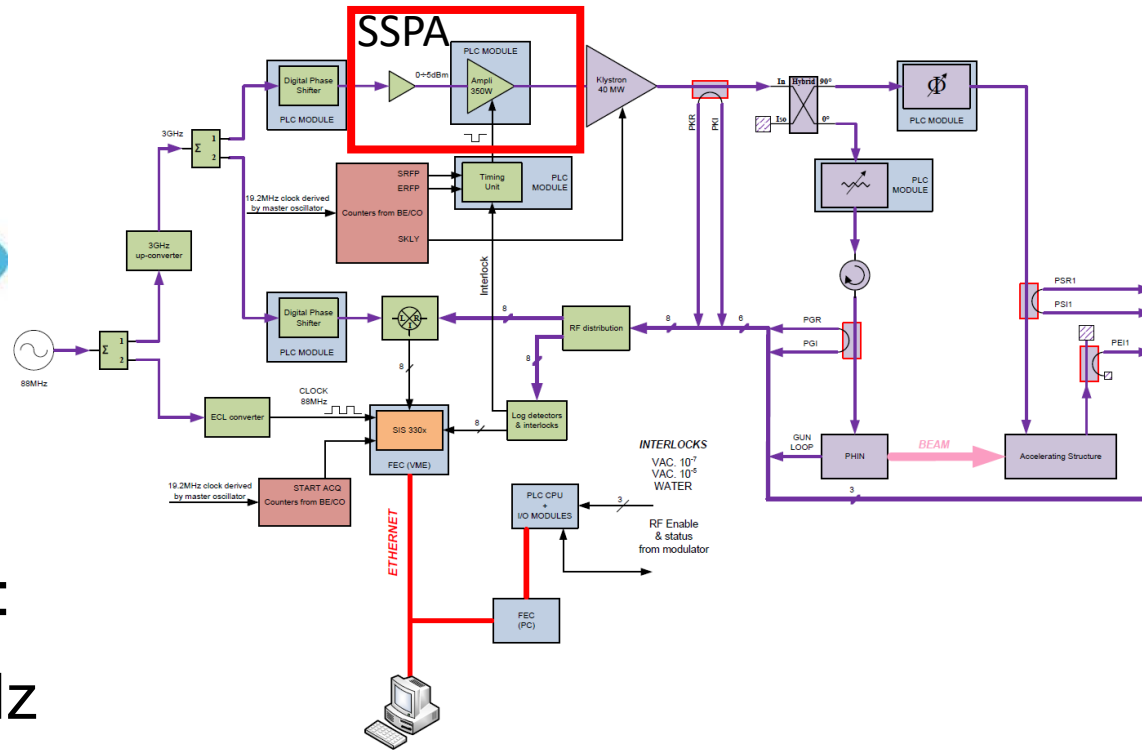
Port2

Port3

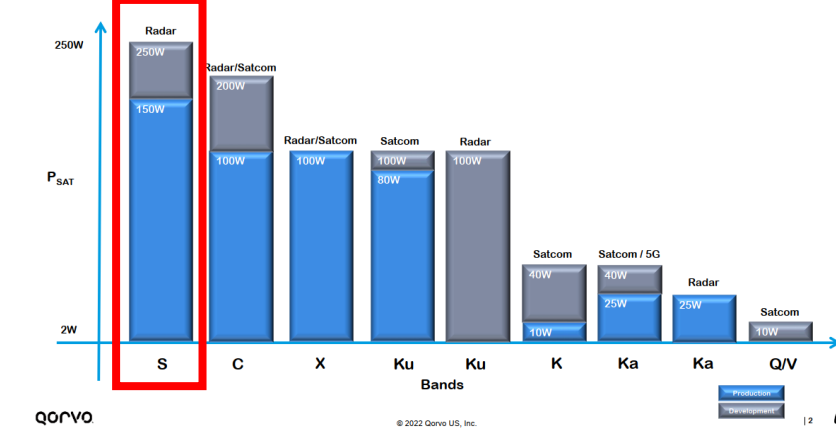
Port4



# Development of SSPA - drivers for the klystrons



Portfolio Summary – MMICs



## Specifications:

@3 GHz

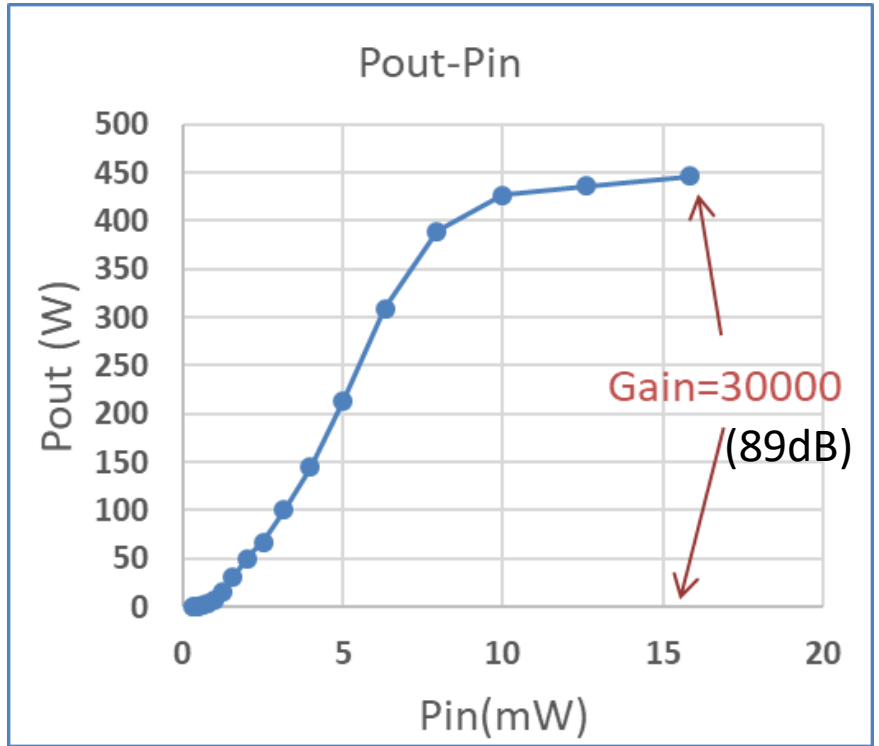
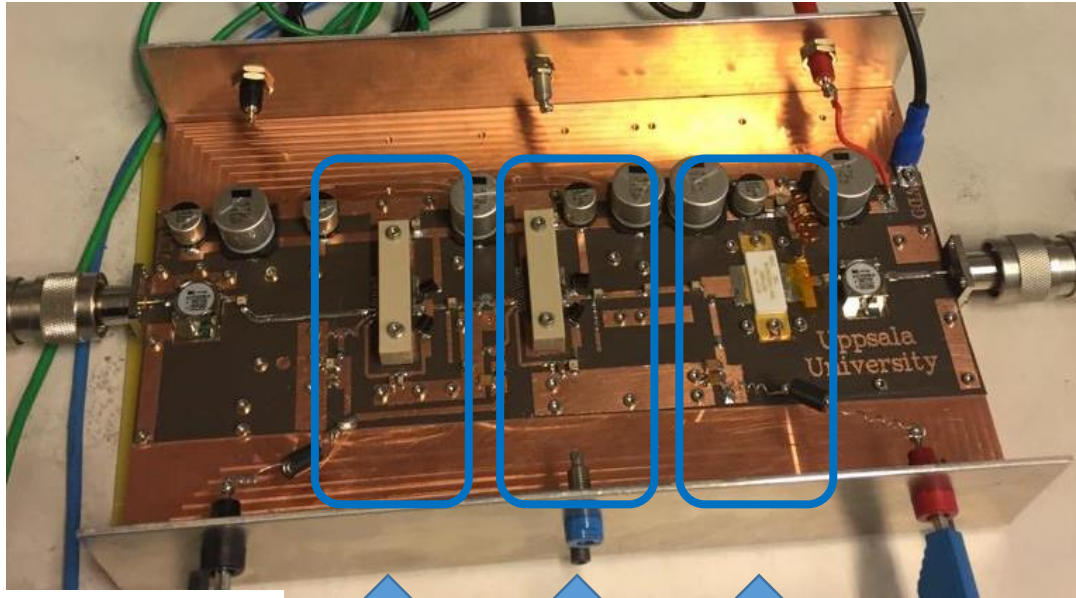
- 1) 200W at the input of the 6 or 7.5 MW S-band klystron

@12 GHz

- 2) 200 W at the input of the 6 MW X-band klystron
- 3) 1000 W at the input of the 50 MW X-band klystron



# 3 GHz – 400 W amplifier at 3 GHz - AWAKE



Pre Driver

**BLM9D2327S-50PB**

Driver

PA



BLS9G2731L-400

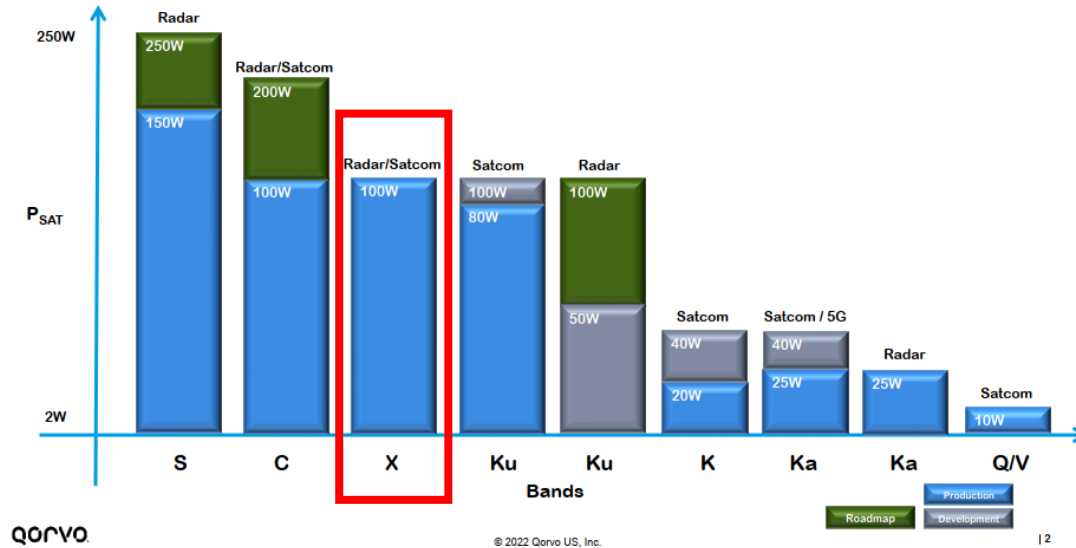
[Download datasheet](#)

[Overview](#)

[Product details](#)



# 12 GHz – 100 W max power available per transistor



Low loss power combiners development is key.

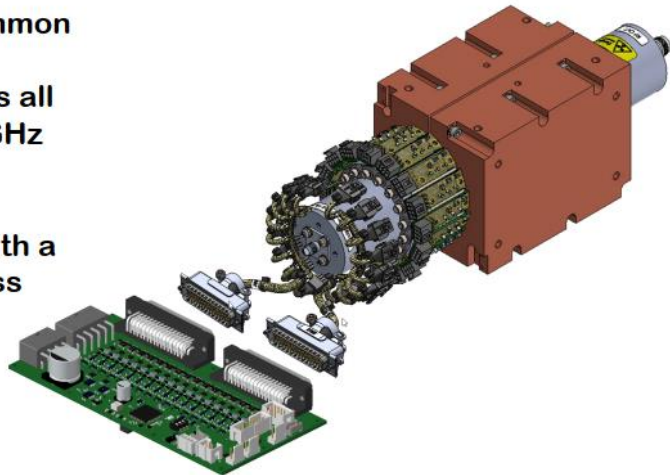
QORVO

© 2022 Qorvo US, Inc.

12



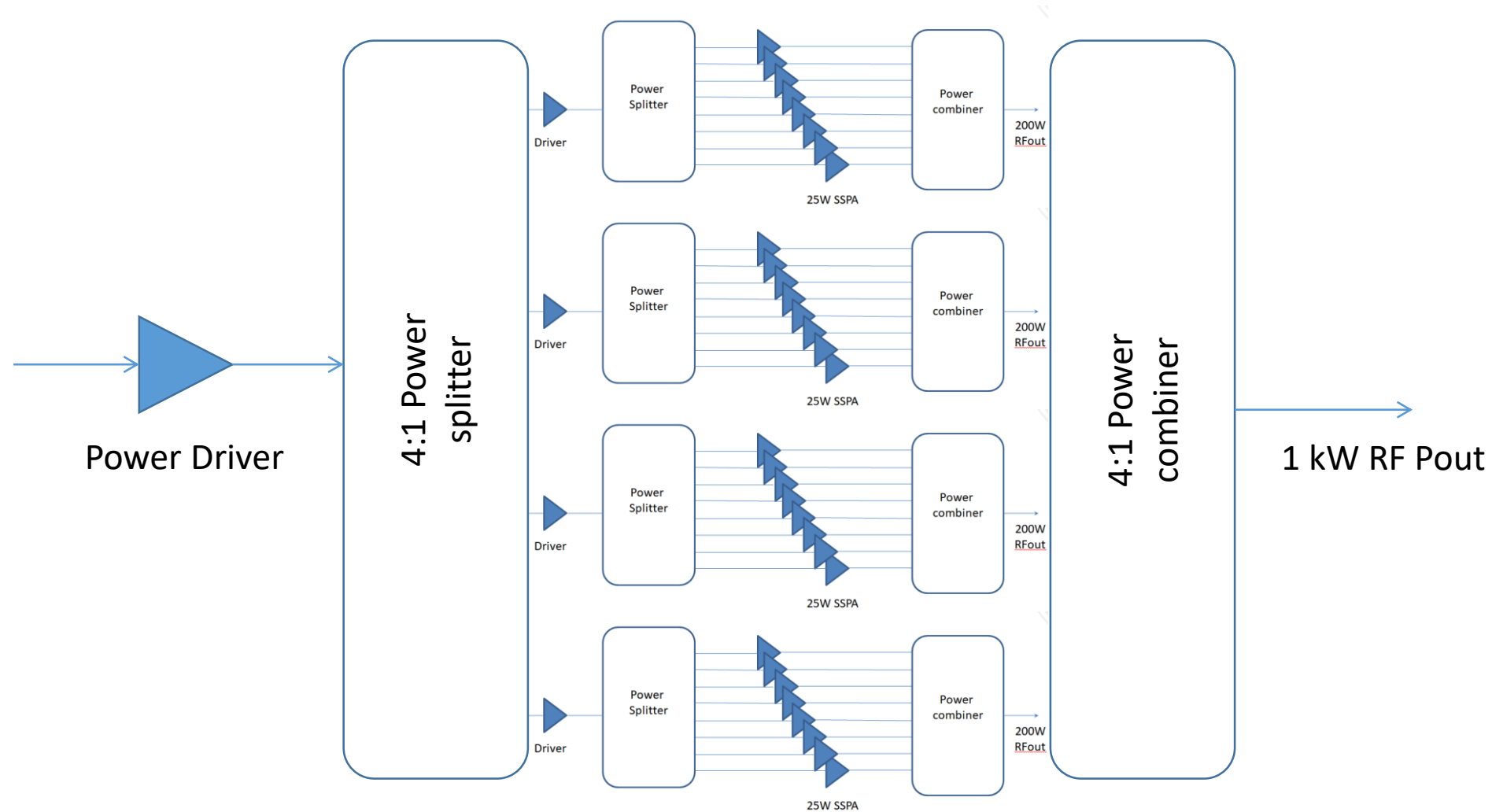
- Qorvo has developed a common Microwave SSPA node for combining 16 MMICs across all or any portion of the 2-20 GHz band
- The SSPA Platform ships with a bias PCB and wiring harness
- The Bias PCB is the SSPA control board



Price tag of this 500 W amplifier is prohibitive, i.e. 50 k\$ and we need to combine 2 of them for the klystron needs, i.e. 1000 W.

Thus, we plan to develop our own power amplifier at X band, based on combining 40+ transistors of 25 W each.

# X-band SSPA – 1 kW SSPA - AWAKE



TBC ...



UPPSALA  
UNIVERSITET

# Thanks for your attention !

## Questions